

Title (en)

Floor panel, method for manufacturing floor panels and transfer foil

Title (de)

Bodenpaneel, Verfahren zur Herstellung von Bodenpaneelen und Transferfolie

Title (fr)

Panneau de plancher, procédé de fabrication des panneaux de plancher et film de transfert

Publication

EP 2113393 B1 20120411 (EN)

Application

EP 08008164 A 20080429

Priority

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Abstract (en)

[origin: EP2113393A1] Floor panel, wherein this floor panel (1) at one or more edges (2-3), next to the upper side (9), is provided with a chamfer (6), wherein the surface (7) of said chamfer (6) is provided with a decorative covering (8), characterized in that said decorative covering (8) comprises at least a first decorative layer (22) and a second decorative layer (23), which decorative layers (22-23) are provided on top of each other, wherein the first decorative layer (22) remains at least partially visible through the second decorative layer (23) provided on top thereof.

IPC 8 full level

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CPC (source: EP)

B44C 1/1712 (2013.01); **B44C 5/04** (2013.01); **B44F 9/02** (2013.01)

Cited by

CN109808395A; CN110217622A; EP4364961A1; WO2022227174A1; WO2023110827A1

Designated contracting state (EPC)

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